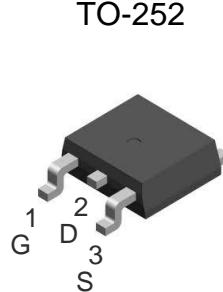
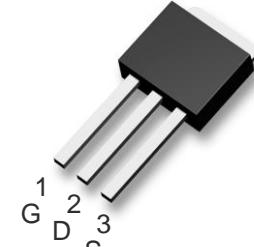
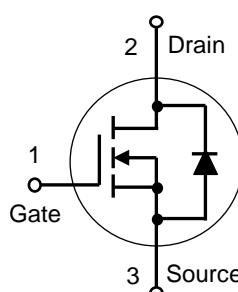


<b>700V / 2A N-Channel Enhancement Mode MOSFET</b>	700V, $R_{DS(ON)}=6.5\Omega$ @ $V_{GS}=10V$ , $I_D=1A$																																								
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<ul style="list-style-type: none"> <li>• Low On-State Resistance</li> <li>• Fast Switching</li> <li>• Low Gate Charge &amp; Low <math>C_{RSS}</math></li> <li>• Fully Characterized Avalanche Voltage and Current</li> <li>• Specially Designened for AC Adapter, Battery Charger and SMPS</li> <li>• In compliance with EU RoHs 2002/95/EC Directives</li> </ul>																																									
 																																									
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<ul style="list-style-type: none"> <li>• Case: TO-252 / TO-251 Molded Plastic</li> <li>• Terminals : Solderable per MIL-STD-750,Method 2026</li> </ul>																																									
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**Electrical Characteristics (  $T_C=25^\circ C$ , Unless otherwise noted )**

Paramter	Symbol	Test Condition	Min.	Typ.	Max.	Units
<b>Static</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	700	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0	-	4.0	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=1A$	-	5.0	6.5	$\Omega$
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=700V, V_{GS}=0V$	-	-	10	$\mu A$
Gate Body Leakage Current	$I_{GSS}$	$V_{GS}=\pm 30V, V_{DS}=0V$	-	-	$\pm 100$	nA
<b>Dynamic</b>						
Total Gate Charge	$Q_g$	$V_{DS}=560V, I_D=2A$ $V_{GS}=10V$	-	6.2	7.8	nC
Gate-Source Charge	$Q_{gs}$		-	1.8	-	
Gate-Drain Charge	$Q_{gd}$		-	2.3	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=350V, I_D=2A$ $V_{GS}=10V, R_G=25\Omega$	-	12.8	16	ns
Turn-On Rise Time	$t_r$		-	26.8	36	
Turn-Off Delay Time	$t_{d(off)}$		-	16.8	28	
Turn-Off Fall Time	$t_f$		-	18.8	32	
Input Capacitance	$C_{iss}$	$V_{DS}=25V, V_{GS}=0V$ $f=1.0MHz$	-	255	-	pF
Output Capacitance	$C_{oss}$		-	32	-	
Reverse Transfer Capacitance	$C_{rss}$		-	1.7	-	
<b>Source-Drain Diode</b>						
Max. Diode Forward Voltage	$I_S$	-	-	-	2.0	A
Max. Pulsed Source Current	$I_{SM}$	-	-	-	8.0	A
Diode Forward Voltage	$V_{SD}$	$I_S=2A, V_{GS}=0V$	-	-	1.4	V
Reverse Recovery Time	$t_{rr}$	$V_{GS}=0V, I_S=2A$ $di/dt=100A/us$	-	210	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	1.1	-	uC

**NOTE :** Pulse Test : Pulse Width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$

## Typical Characteristics Curves ( $T_C=25^\circ\text{C}$ , unless otherwise noted)

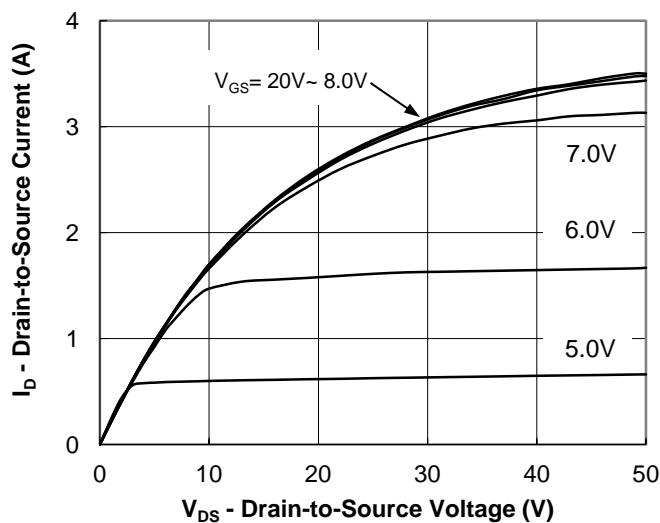


Fig.1 Output Characteristic

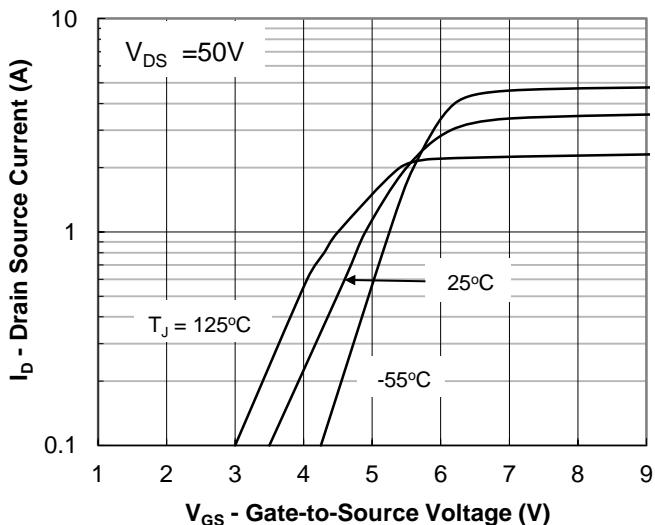


Fig.2 Transfer Characteristic

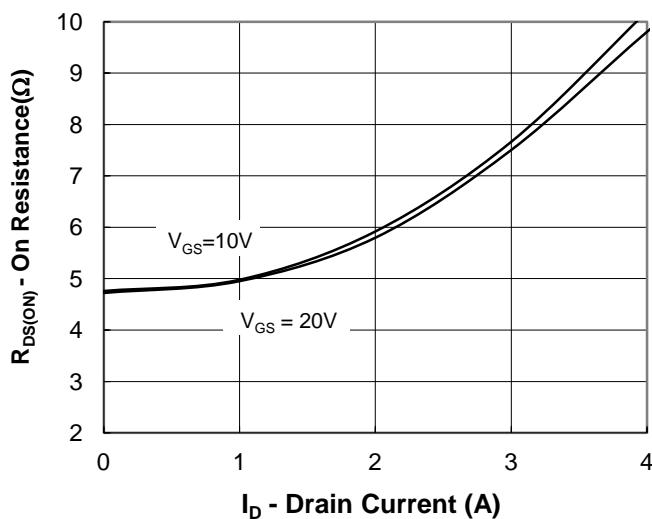


Fig.3 On-Resistance vs Drain Current

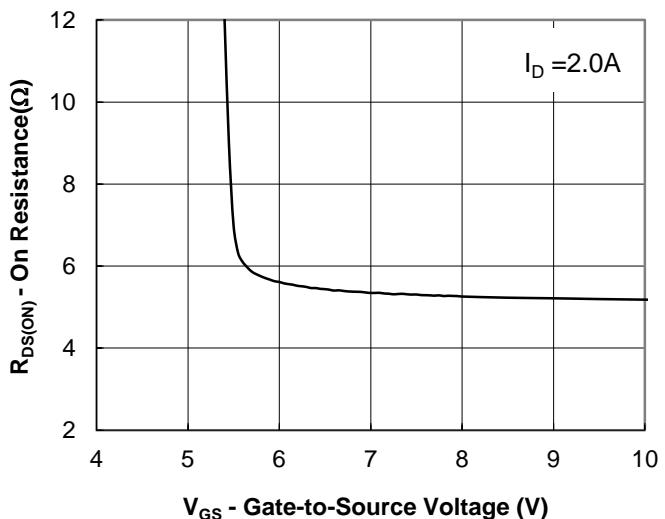


Fig.4 On-Resistance vs Gate to Source Voltage

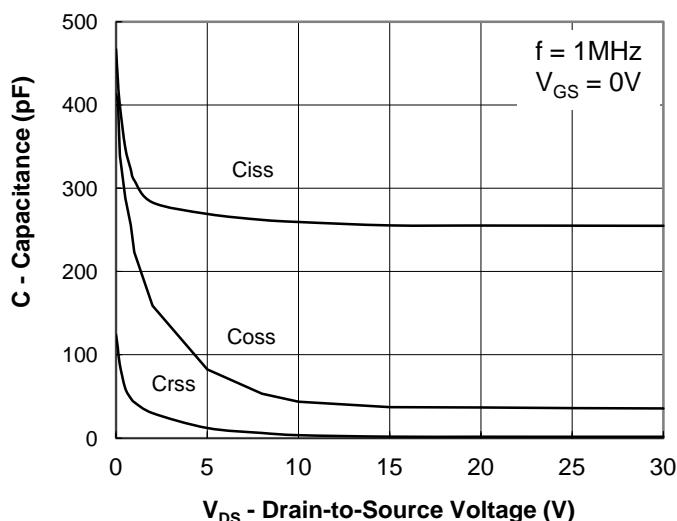


Fig.5 Capacitance Characteristic

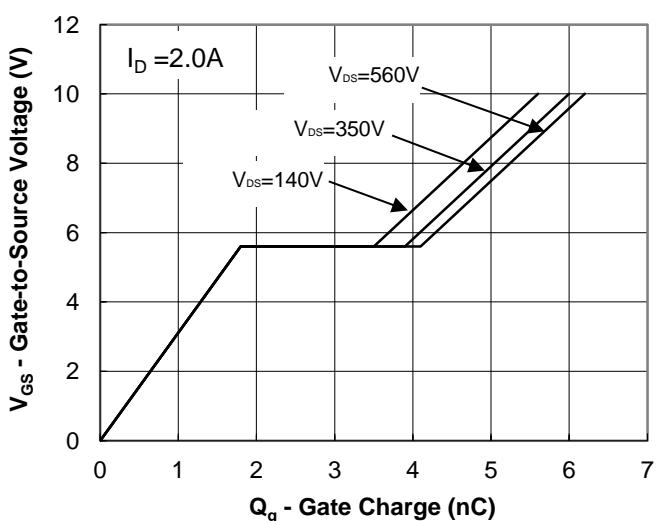
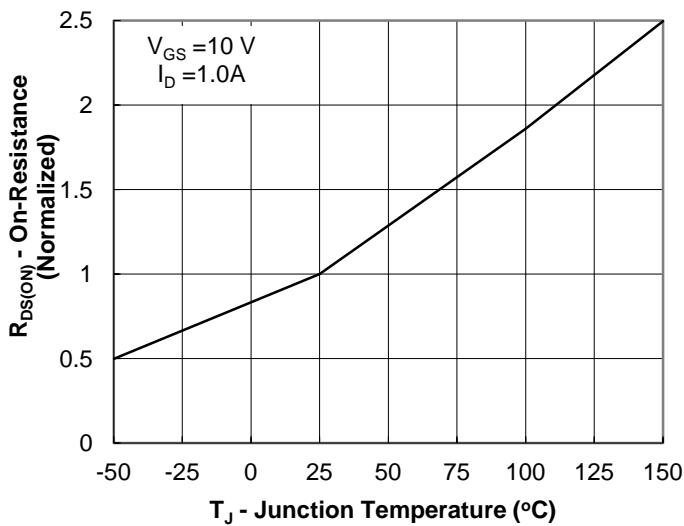
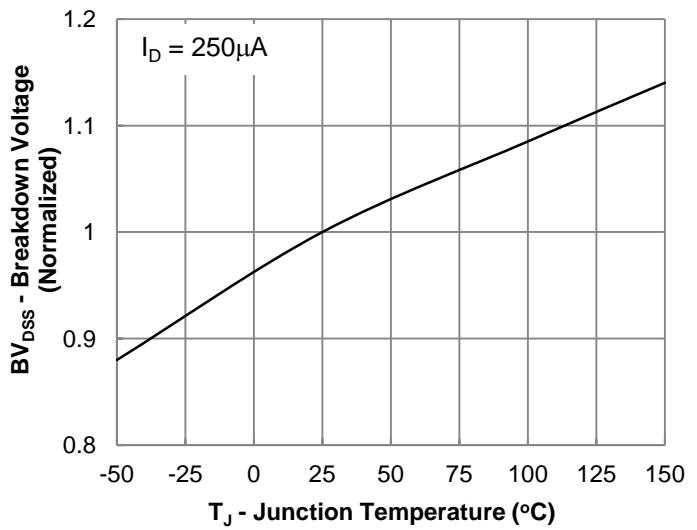
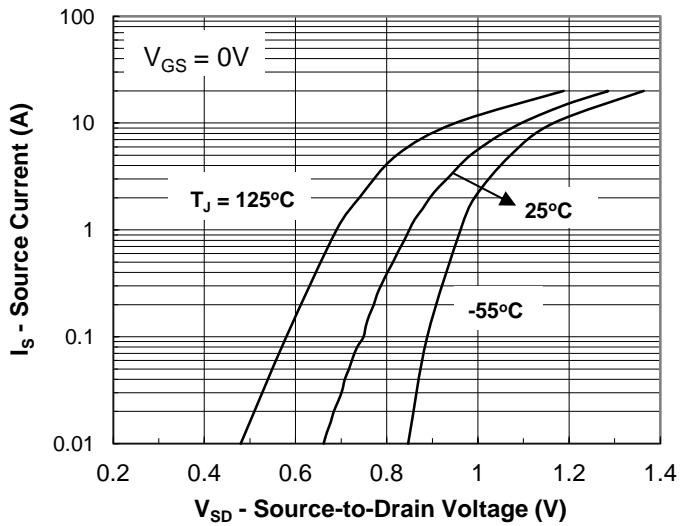


Fig.6 Gate Charge Characteristic

**Typical Characteristics Curves (  $T_C=25^\circ\text{C}$ , unless otherwise noted)**

**Fig.7 On-Resistance vs Junction Temperature**

**Fig.8 Breakdown Voltage vs Junction Temperature**

**Fig.9 Body Diode Forward Voltage Characteristic**